HV MFM™ Filter

MFM1714xD2KD2F4yzz

High Voltage MIL-COTS Input Filter Module

Features & Benefits

- 270V Nominal input
- 99% efficiency
- EMI filtering
  - MIL-STD-461E/F, selected CE and CS tests
- Input Transient protection
  - MIL-STD-704F
    Normal and Abnormal Transients
- Envronmental qualification
  - MIL-STD-810
  - MIL-STD-202
- Low M grade temperature rating, providing operation down to -55°C
- Output power up to 640W
- Available in chassis and PCB mount
- Small size
  - 1.76" x 1.40" x 0.36"
    (44.6mm x 35.5mm x 9.2mm)

Typical Applications

- Defense
- Aerospace

Compatible Products

- High input voltage DCM in a VIA Package
- High input voltage ChiP [1] DCM

Product Description

The MFM DCM Filter is a DC front-end module that provides EMI filtering and transient protection. The MFM DCM Filter enables designers using Vicor's 270V nominal input voltage VIA or ChiP [1] modules to meet conducted emission/conducted susceptibility per MIL-STD-461E/F; and input transients per MIL-STD-704F.
The MFM DCM Filter accepts an input voltage of 160 – 420V_{DC} (270V nominal input) and delivers output power up to 640W.

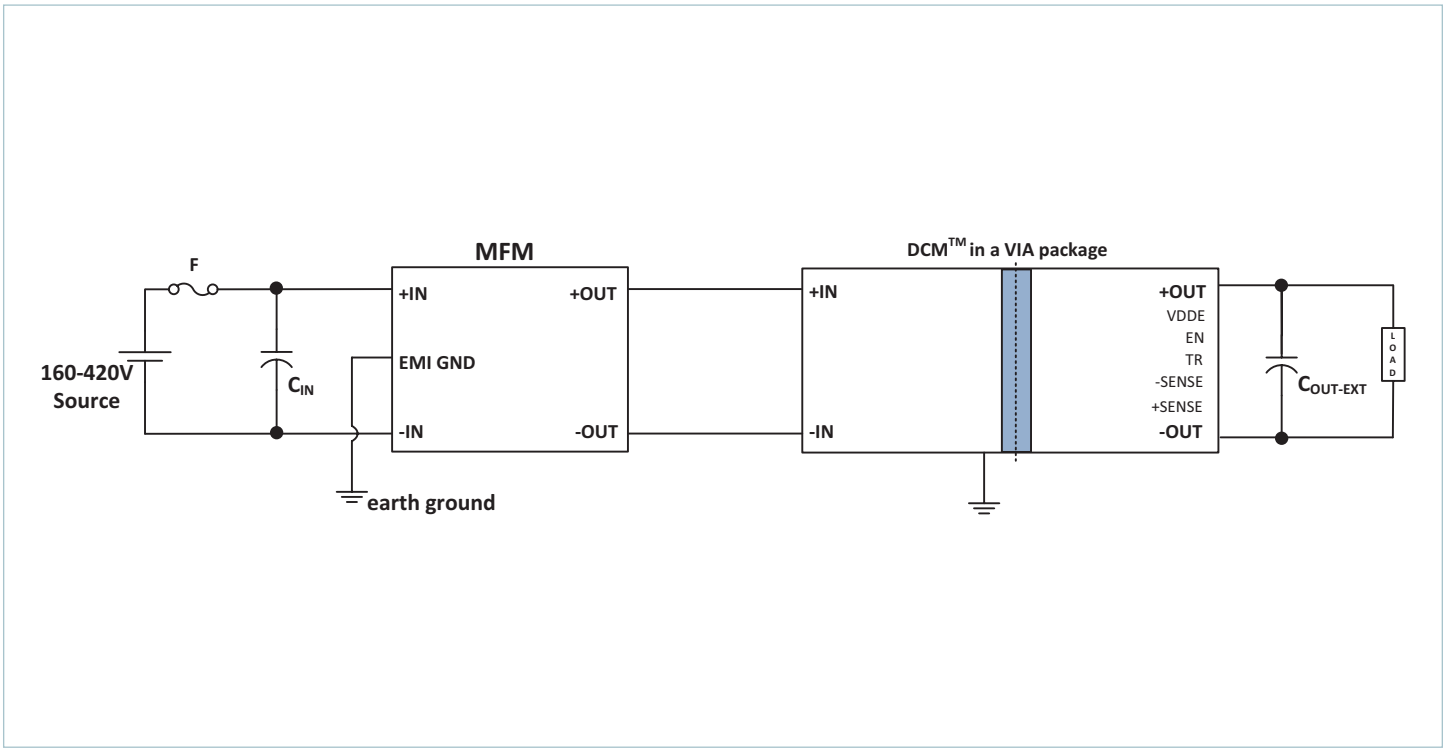
Size:
1.76 x 1.40 x 0.36in
44.6 x 35.5 x 9.2mm

[1] Additional components are required for EMI filtering and transient suppression, when used with ChiP modules.

Part Ordering Information

Product Function	Package Length	Package Width	Package Type	Max High Side Voltage	High Side Voltage Range Ratio	Max Low Side Voltage	Max Low Side Current	Product Grade (Case Temperature)	Option Field
MFM	17	14	x	D2	K	D2	F4	y	zz
MFM = MIL-COTS Input Filter Module	Length in Inches x 10	Width in Inches x 10	B = Board VIA V = Chassis VIA	Internal Reference				M = -55 to 100°C	00 = Chassis 04 = Short Pin 08 = Long Pin

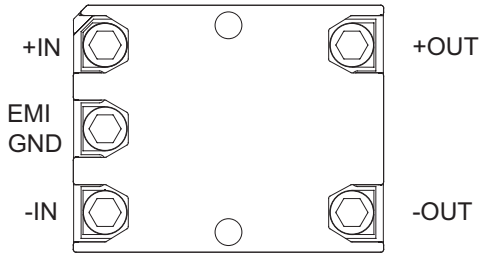
Typical Application



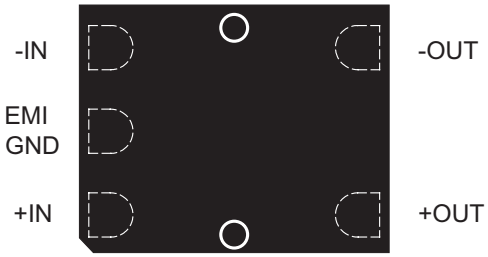
DCM in a VIA package with a MFM input filter, to meet the MIL-STD-461E/F requirements

Parts List for Typical Applications	
F	**Littelfuse** 0487 Series rated 8A **Cooper/Bussman** PC-Tron Series, fast acting fuses rated 5A

Pin Configuration



MFM Filter in a VIA Package - Chassis (Lug) Mount - Terminals Up



MFM Filter in a VIA Package - PCB Mount - Pins Down

Note: These Pin drawings are not to scale.

Pin Descriptions

Signal Name	Type	Function
+IN	INPUT POWER	Positive input power terminal
–IN	INPUT POWER RETURN	Negative input power terminal
EMI GND	EMI GROUND	EMI ground terminal
+OUT	OUTPUT POWER	Positive output power terminal
–OUT	OUTPUT POWER RETURN	Negative output power terminal

Absolute Maximum Ratings

The absolute maximum ratings below are stress ratings only. Operation at or beyond these maximum ratings can cause permanent damage to the device. Electrical specifications do not apply when operating beyond rated operating conditions.

Parameter	Comments	Min	Max	Unit
Input Voltage (+IN to –IN)		-0.5	460.0	V
Output Voltage (+OUT to –OUT)		-0.5	460.0	V
Dielectric Withstand (Input/Output to EMI GND/Case)			2121	V_{DC}
Storage Temperature	M-Grade	-65	125	°C
Internal Operating Temperature	M-Grade	-55	125	°C
Average Output Current			4	A
Input/Output Pin Torque and Mounting Torque			4 (0.45)	in-lbs (N-m)

Electrical Specifications

Specifications apply over all line and load conditions, unless otherwise noted; **boldface** specifications apply over the temperature range of -55°C ≤ T_{CASE} ≤100°C (M-Grade); all other specifications are at T_{CASE} = 25°C unless otherwise noted.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Power Input / Output Specification						
Input Voltage Range	V_{IN}	Continuous operation	160	270	420	V
Maximum Output Current[2]	I_{OUT_MAX}	Continuous, at V_{OUT} = 160V ($I_{OUT} = P_{OUT}/V_{IN}$)			4	A
Rated Output Power[2]	P_{OUT}	Continuous, over all line conditions			640	W
Internal Voltage Drop		@270V, 2.37A, 100°C baseplate			**0.80**	V_{DC}
Efficiency	η	Full load, low line, high temperature	**99.4**	99.6	99	%
		Full load, nominal line, high temperature	**99.7**	99.8		%
		Full load, high line, high temperature	**99.8**	99.9		%

[2] One MFM for each DCM even if the total power of the DCM is below P_{OUT} maximum value.

EMI/EMC

Standard	Test Procedure	Notes
MIL-STD-461E/F		
Conducted Emmisions	CE101	Figure CE101-4, Navy ASW & Army Aircraft, Curve #1 (above 28V_{DC})
	CE102	Figure CE102-1, Basic curve + 10dB limit relaxation for all applications
Conducted Susceptibility	CS101	Figure CS101, Curve #1, for all applications (above 28V_{DC})
MIL-HDBK-704-7		
Transient Immunity	MIL-STD-704F normal transients	From table HDC105-III: Overvoltage 330V_{DC} for 20ms duration, Undervoltage 200V_{DC} for 50msec duration
	MIL-STD-704F abnormal transients	From table HDC302-III: Overvoltage 350V_{DC} for 50ms duration, Undervoltage 180V_{DC} for 50ms duration

Typical Characteristics

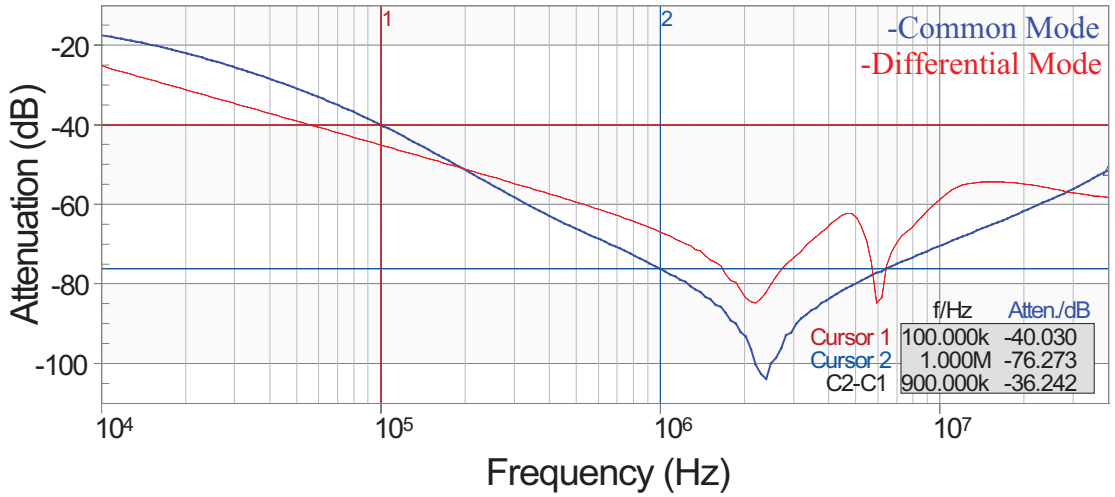


Figure 1 — *Attenuation (dB) vs. Frequency (Hz), input leads are terminated with LISN impedances 25Ω for common mode, 100Ω for differential mode*

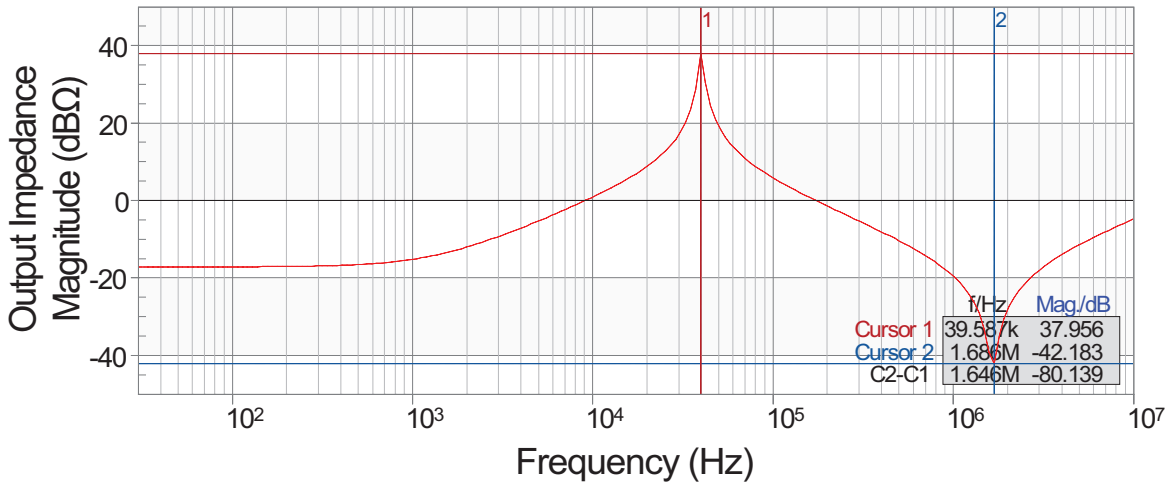


Figure 2 — *Output Impedance (dBΩ) vs. Frequency (Hz) plot looking back into the output terminals of the MFM with shorted input terminals*

Typical Conducted Emissions

CE101 peak scans with MFM1714VD2KD2F4M00 and DCM3714VD2K31E0T01, –OUT connected to GND, –OUT is floating.

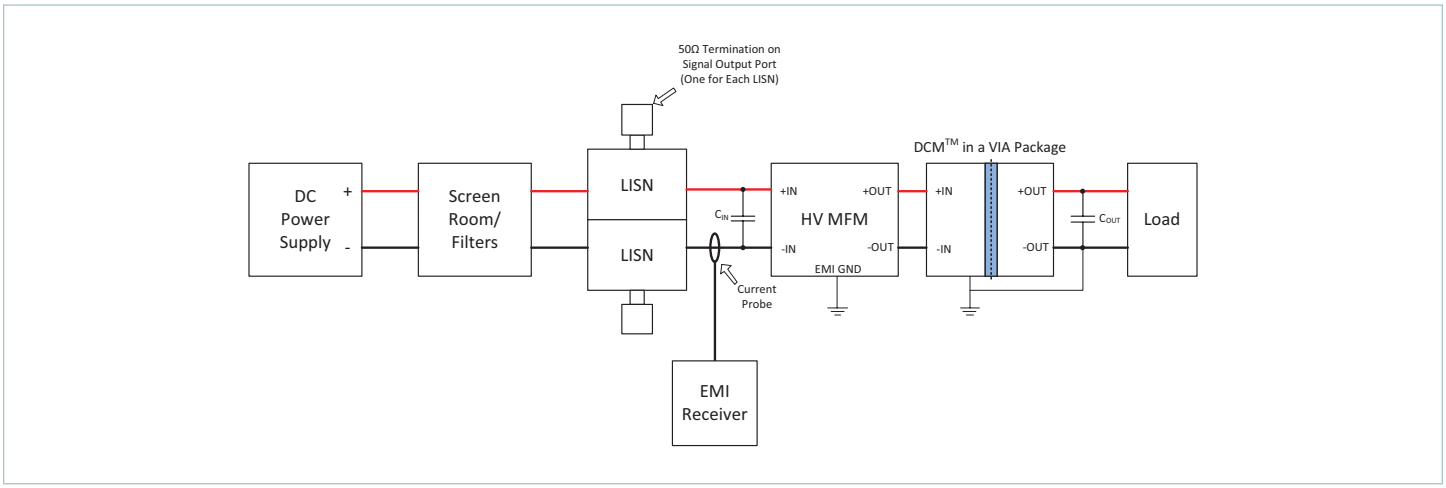


Figure 3 — *A typical test setup for conducted emissions CE101 is shown above. A current probe is used to measure and plot the variations in the current through the RED and BLACK leads at various load conditions.*

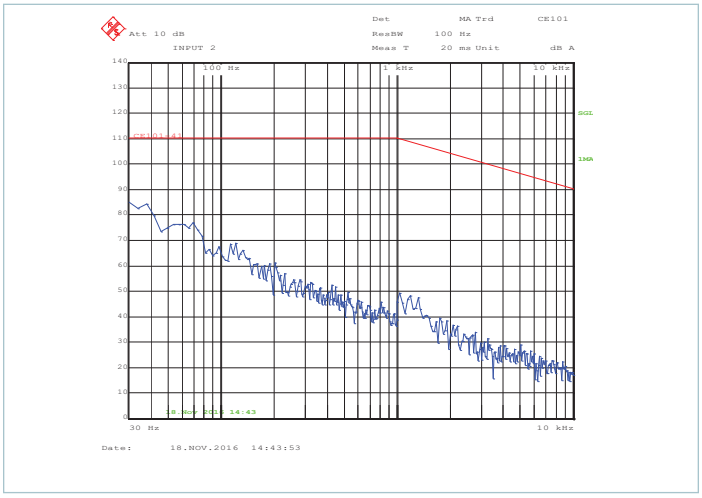


Figure 4 — *Peak scan for the RED lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 0% load*

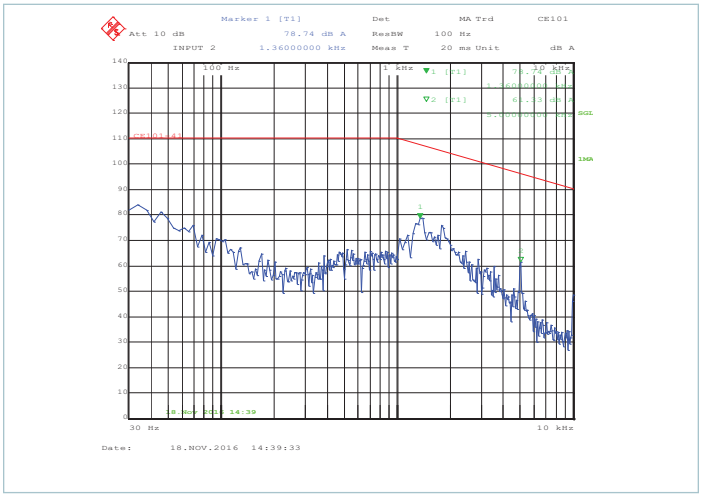


Figure 5 — *Peak scan for the RED lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 100% load*

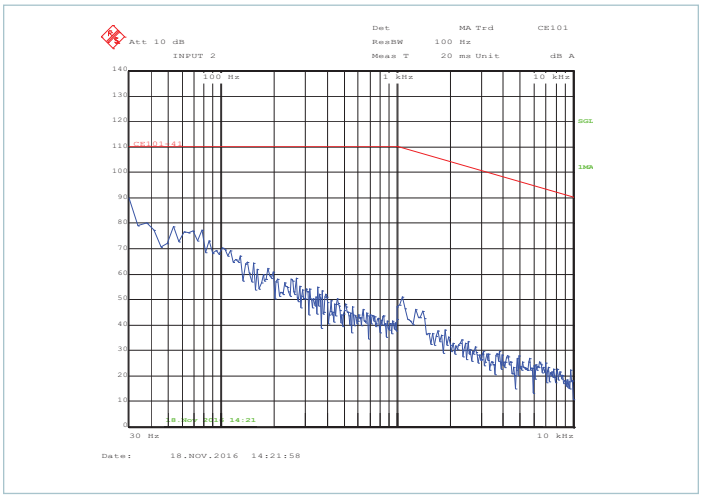


Figure 6 — *Peak scan for the BLACK lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 0% load*

Figure 7 — *Peak scan for the BLACK lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 100% load*

Typical Conducted Emissions (Cont.)

CE102 peak scans with MFM1714VD2KD2F4M00 and DCM3714VD2K31E0T01, –OUT connected to GND, –OUT is floating.

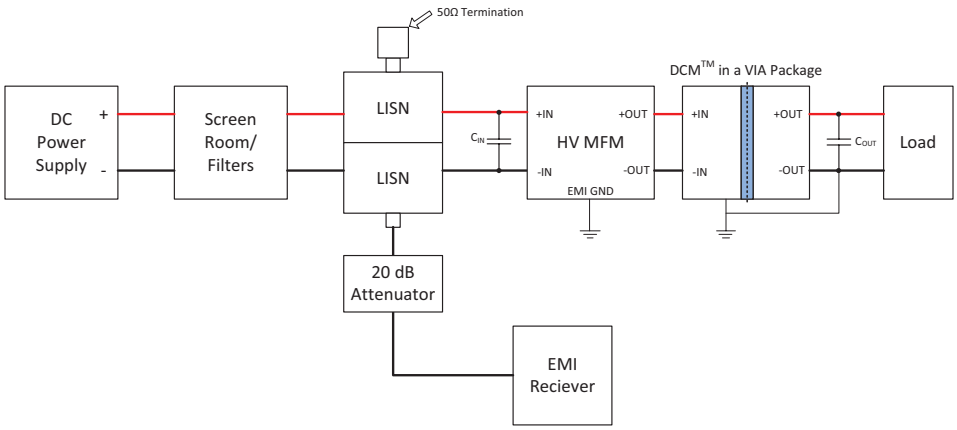


Figure 8 — *A typical test setup for conducted emissions CE102 is shown above. A 50Ω termination is used for LISN and voltage across the RED and BLACK leads are measured at various load conditions.*

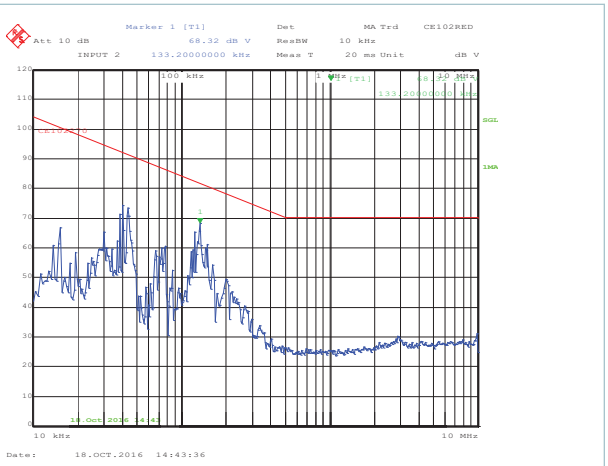


Figure 9 — *Peak scan for the RED lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 0% load*

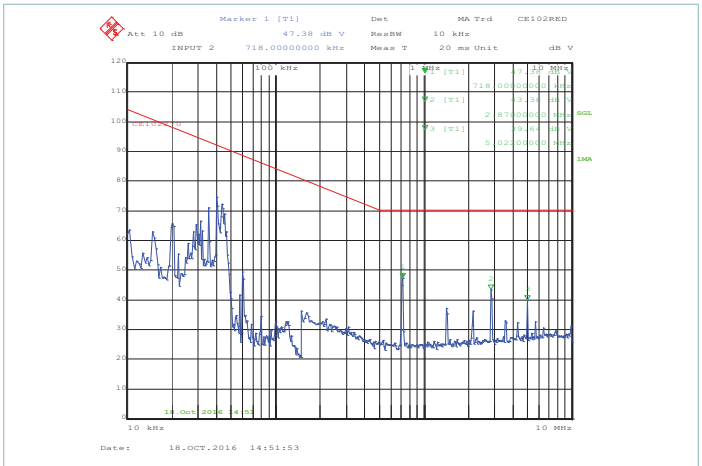


Figure 10 — *Peak scan for the RED lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 100% load*

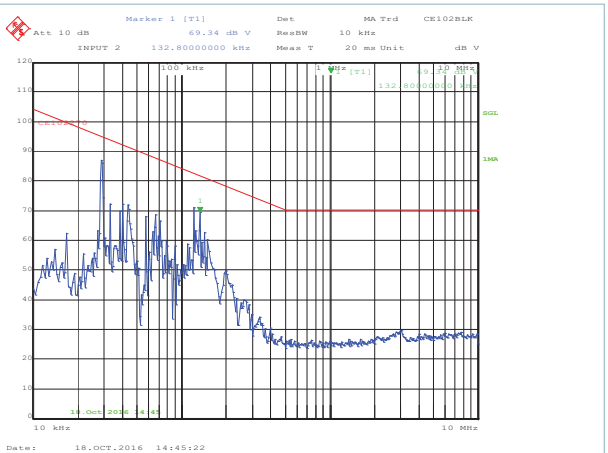


Figure 11 — *Peak scan for the BLACK lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 0% load*

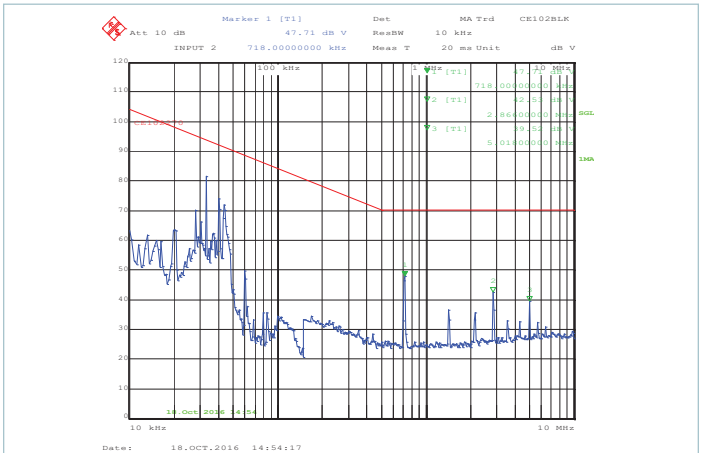


Figure 12 — *Peak scan for the BLACK lead with C_{IN} = 100µF, C_{OUT} = 2000µF, 100% load*

General Characteristics

Specifications apply over all line and load conditions, T_J = 25°C, unless otherwise noted; **boldface** specifications apply over the temperature range of the specified product grade.

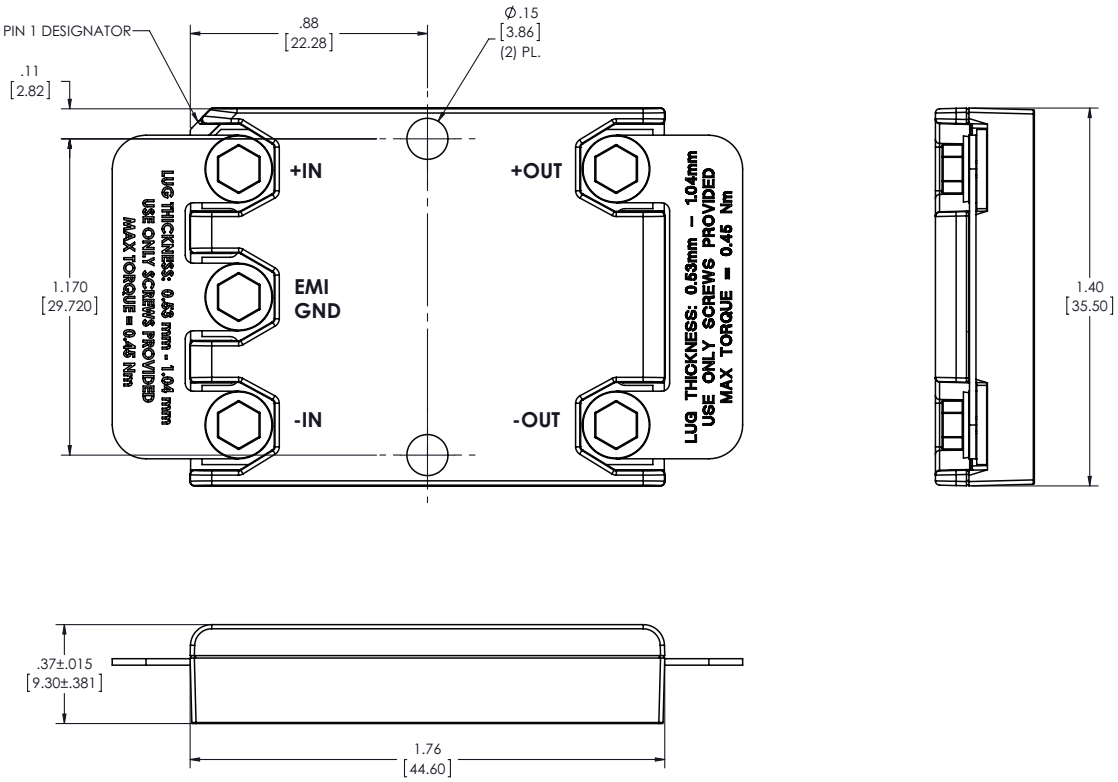
Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Mechanical						
Length	L			44.6 / [1.76]		mm / [in]
Width	W			35.5 / [1.39]		mm / [in]
Height	H			9.22 / [0.36]		mm / [in]
Volume	Vol	Without heatsink		14.5 / [0.88]		cm^3/ [in^3]
Mass (Weight)	M			30 / [1.06]		g / [oz]
Pin Material		C145 copper, 1/2 hard				
Underplate		Low stress ductile Nickel	50		100	µin
Pin Finish		Palladium	0.8		6	µin
		Soft Gold	0.12		2	
Flatness					<0.25 / [0.010]	mm / [in]
Thermal						
Internal Operating Temperature[3]		M-Grade	-55		125	°C
Case Temperature		M-Grade	-55		100	
Thermal Tesistance, Junction to Case Bottom	θ_{INT_BOT}			6.5		°C/W
Soldering						
Temperature		See: AN:401 PCB Mount VIA Soldering Guidelines				
Reliability						
MTBF		MIL-HDBK-217FN2 Parts Count - 25°C Ground Benign, Stationary, Indoors / Computer	60			MHrs
Safety						
Dielectric Withstand		Input / Output to EMI GND/Case	2121			V_{DC}
Agency Approvals / Standards						
		CE marked for Low Voltage Directive (LVD) 2014/35/EU, EN60950-1				

[3] Internal operating temperatures will be kept to acceptable limits if the lower housing of the unit is mounted to a metal plate (coldplate or heatsink) with thermal grease that is kept to 100°C or less. If the unit is not mounted to a metal plate than a thermocouple on the bottom housing located midway between the two mounting holes needs to be kept to 100°C or less.

Environmental Qualification

Testing Activity	Reference Standard	Test Details
HTOB-HTOL High Temperature Operating Bias/Life	JESD22-A110-B	Duration of 1000 hrs, High Line, full load, max operating temperature, Power cycled per IPC9592
TC (Temperature Cycling)	JESD22-A104D	1000 cycles -55°C to 125°C
HALT (Highly Accelerated Life Test)	DP-0266	Low Temp, High Temp, Rapid Thermal Cycling, Random Vibration Test, Combined Stress Test
THB (Temperature Humidity Bias)	JEDSD22-A101C	Duration of 1000hrs, Biased, 85°C, 85%RH.
HTS (High Temperature Storage)	JESD 22-A103-D	Duration 1000hrs , No Bias. Maximum storage temperature (125°C)
LTS (Low Temperature Storage)	JESD22–A119	Duration 1000 hrs , No Bias. Minimum storage temperature (-65°C)
Random Vibration	MIL-STD-810G	Method 514.6, Procedure I, Category 24, Mounted on QA
Mechanical Shock	MIL-STD-810G	Method 516.5, Procedure I, Environment: Functional shock 40G, Mounted on QA
Electro Static Discharge Human Body Model	JEDEC JS-001-2012	Table 2B, Class 2, ±2000V minimum
Electro Static Discharge Device Charge Model	JESD22-C101-E	Class III ±500V minimum
Free Fall	IPC9592B	IEC 60068-2-32, Freefall procedure 1
Term Strength	MIL-STD-202G	Method 211A,Test Condition A, Environment: Ambient Temperature & %Rh.
Through Hole Solderability	IPC-9592B	IPC/ECA J-STD-002 Test A (dip and look)
Salt Fog	MIL-STD-810G	Method 509.5
Fungus	MIL-STD-810G	Method 508.6
Resistance to solvents	MIL-STD-202G	Method 215K
Acceleration	MIL-STD-810G	Method 513.6 Procedure II
Altitude	MIL-STD-810G	Method 500.5 Procedure I & II
Explosive Atmosphere	MIL-STD-810G	Method 511.5 Procedure I, operational

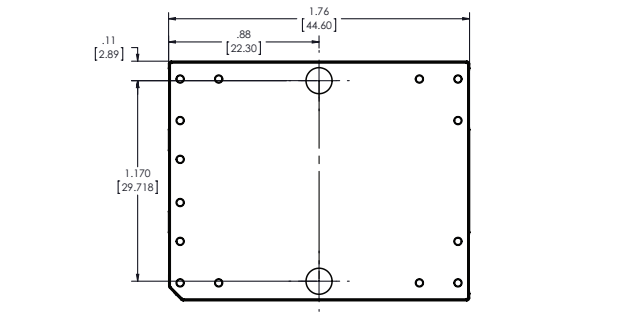
Chassis Mount Outline Drawing



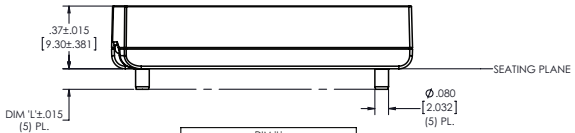
NOTE:

1. RoHS COMPLIANT PER CST-0001 LATEST REVISION

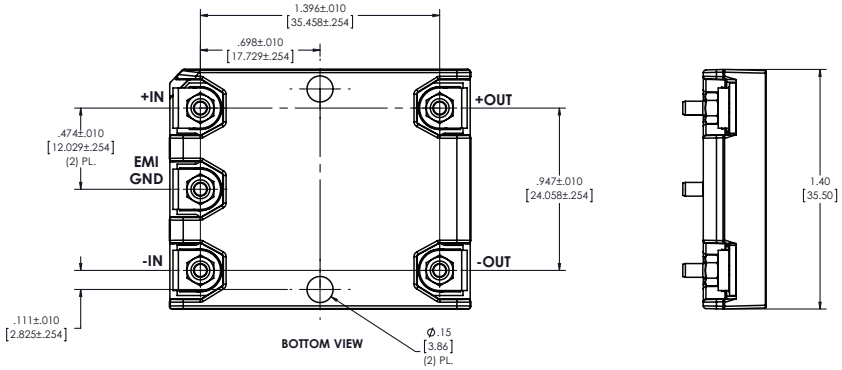
Board Mount Outline Drawing



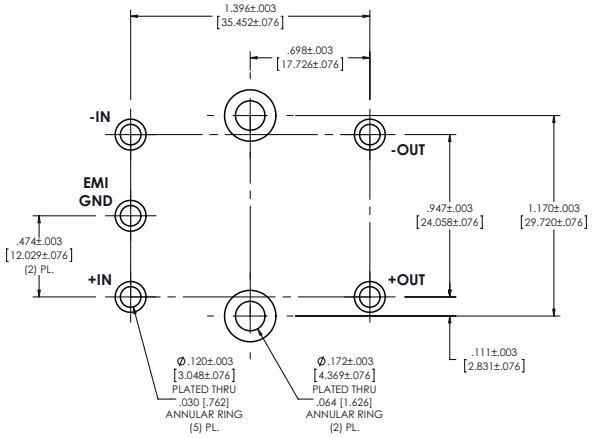
TOP VIEW
(COMPONENT SIDE)



DIM 'L'	
SHORT	.120 [3.026]
LONG	.199 [5.042]



BOTTOM VIEW



RECOMMENDED HOLE PATTERN
(COMPONENT SIDE)

NOTE:
1. RoHS COMPLIANT PER CST-0001 LATEST REVISION

Revision History

Revision	Date	Description	Page Number(s)
1.0	02/13/17	Initial release	n/a
1.1	06/15/17	Updated product image	7, 8
1.2	07/26/17	Added fuse recommendation for typical application & remvoed MOV Updated internal operting temperature Updated note on CE scans for –OUT floating Updated MTBF rating	2 4 7, 8 9

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